

BUJ105AD Silicon diffused power transistor Rev. 4 – 13 July 2018

Product data sheet

1. Product profile

1.1 General description

High-voltage, high-speed planar-passivated NPN power switching transistor in a SOT428 (D-PAK) surface mounted package.

1.2 Features and benefits

Low thermal resistance
 Fast switching

1.3 Applications

- Electronic lighting ballast
- Inverters

1.4 Quick reference data

- V_{CESM} ≤ 700 V
- $P_{tot} \le 80 \text{ W}$

- DC-to-DC convertersMotor control systems
- I_C ≤ 8 A
 h_{FEsat} = 11 (typ)

2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	base	mb	
2	collector		2
3	emitter		. /
mb	mounting base; connected to collector	الـــــا	
			3
			sym056
		DPAK (SOT428)	

[1] It is not possible to make a connection to pin 2 of the SOT428 (D-PAK) package.

3. Ordering information

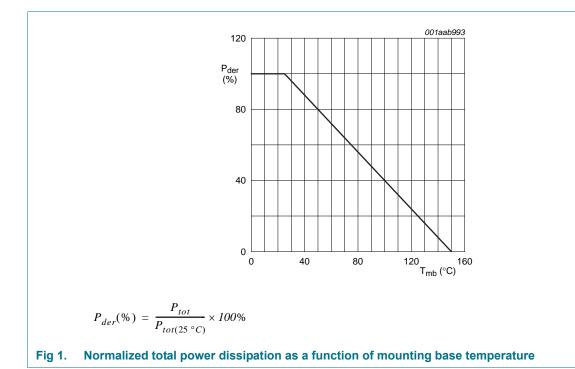
Table 2. Ordering information						
Type number	Package					
	Name	Description	Version			
BUJ105AD	D-PAK	plastic single-ended surface mounted package; 3 leads (one lead cropped)	SOT428			

4. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CESM}	peak collector-emitter voltage	$V_{BE} = 0 V$	-	700	V
V _{CEO}	collector-emitter voltage	open base	-	400	V
V _{CBO}	collector-base voltage	open emitter	-	700	V
I _C	collector current (DC)		-	8	А
I _{CM}	peak collector current		-	16	А
I _B	base current (DC)		-	4	А
I _{BM}	peak base current		-	8	А
P _{tot}	total power dissipation	T_{mb} = \leq 25 °C; see <u>Figure 1</u>	-	80	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

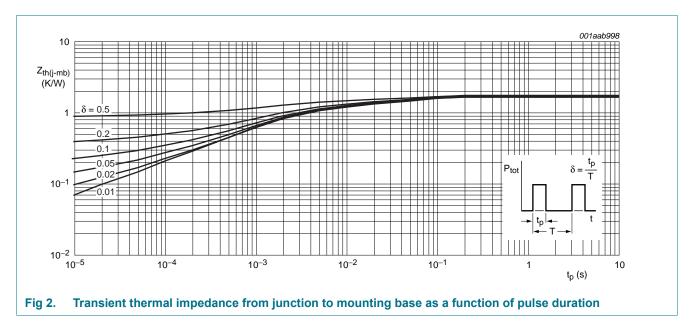


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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 2	-	-	1.56	K/W
R _{th(j-a)}	thermal resistance from junction to ambient		<u>[1]</u> _	75	-	K/W

[1] Device mounted on a printed-circuit board; minimum footprint



6. Characteristics

Table 5. Characteristics

 $T_{mb} = 25 \ ^{\circ}C$; unless otherwise specified.

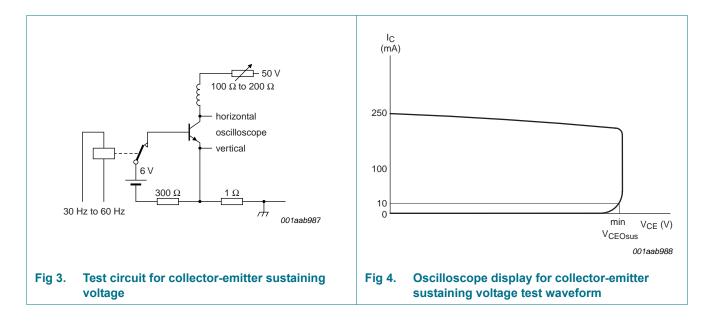
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Static cha	Static characteristics						
I _{CES}	collector-emitter cut-off current	$V_{BE} = 0 V; V_{CE} = V_{CESMmax}$	<u>[1]</u>	-	-	0.2	mA
		$V_{BE} = 0 \text{ V}; V_{CE} = V_{CESMmax}; T_j = 125 ^{\circ}\text{C}$	<u>[1]</u>	-	-	0.5	mA
I _{CBO}	collector-base cut-off current	$V_{BE} = 0 V; V_{CE} = V_{CESMmax}$	<u>[1]</u>	-	-	0.2	mA
I _{CEO}	collector-emitter cut-off current	$V_{CEO} = V_{CEOMmax} = 400 V$	<u>[1]</u>	-	-	0.1	mA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 9 V; I_C = 0 A$		-	-	1	mA
V _{CEOsus}	collector-emitter sustaining voltage	$I_B = 0 \text{ A}; I_C = 10 \text{ mA}; L = 25 \text{ mH};$ see <u>Figure 3</u> and <u>4</u>		400	-	-	V
V _{CEsat}	collector-emitter saturation voltage	$I_{C} = 4.0 \text{ A}; I_{B} = 0.8 \text{ A}; \text{ see } \frac{\text{Figure 11}}{1000000000000000000000000000000000$		-	0.3	1.0	V
V _{BEsat}	base-emitter saturation voltage	$I_{C} = 4.0 \text{ A}; I_{B} = 0.8 \text{ A}; \text{ see } \frac{\text{Figure } 12}{12}$		-	1.0	1.5	V
h _{FE}	DC current gain	$I_{C} = 1 \text{ mA}; V_{CE} = 5 \text{ V}$		10	14	34	
		$I_C = 500 \text{ mA}; V_{CE} = 5 \text{ V}; \text{ see } \frac{\text{Figure 10}}{10}$		13	23	36	
h _{FEsat}	DC saturation current gain	$I_{C} = 4.0 \text{ A}; V_{CE} = 5 \text{ V}$		8	11	15	

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Silicon diffused power transistor

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Dynamic	characteristics					
Switching	times (resistive load); see Fig	gure <u>5</u> and <u>6</u>				
t _{on}	turn-on time	I_{Con} = 5 A; I_{Bon} = $-I_{Boff}$ = 1 A; R_L = 75 Ω	-	0.65	1	μS
t _{stg}	storage time		-	1.8	2.5	μS
t _f	fall time		-	0.3	0.5	μs
Switching	times (inductive load); see <u>Fi</u>	gure 7 and <u>8</u>				
t _{stg}	storage time	$I_{Con} = 5 \text{ A}; I_{Bon} = 1 \text{ A}; L_B = 1 \mu\text{H};$	-	1.2	1.7	μs
t _f	fall time	$V_{BB} = -5 V$	-	20	50	ns
Switching	times (inductive load); see Fi	gure 7 and <u>8</u>				
t _{stg}	storage time	$I_{Con} = 5 \text{ A}; I_{Bon} = 1 \text{ A}; L_B = 1 \mu\text{H};$	-	1.4	1.9	μS
t _f	fall time	V _{BB} = -5 V; T _j = 100 °C	-	25	100	ns

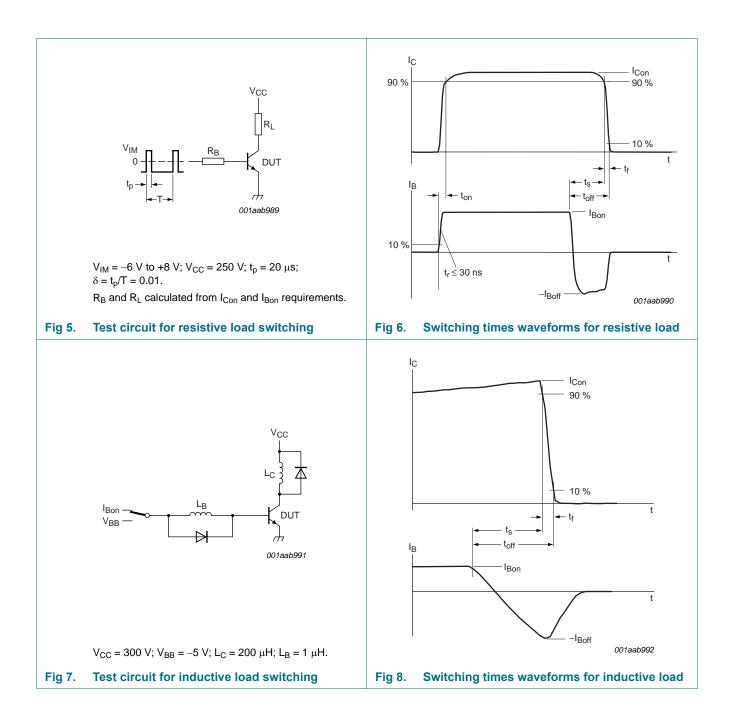
[1] Measured with half sine-wave voltage (curve tracer).



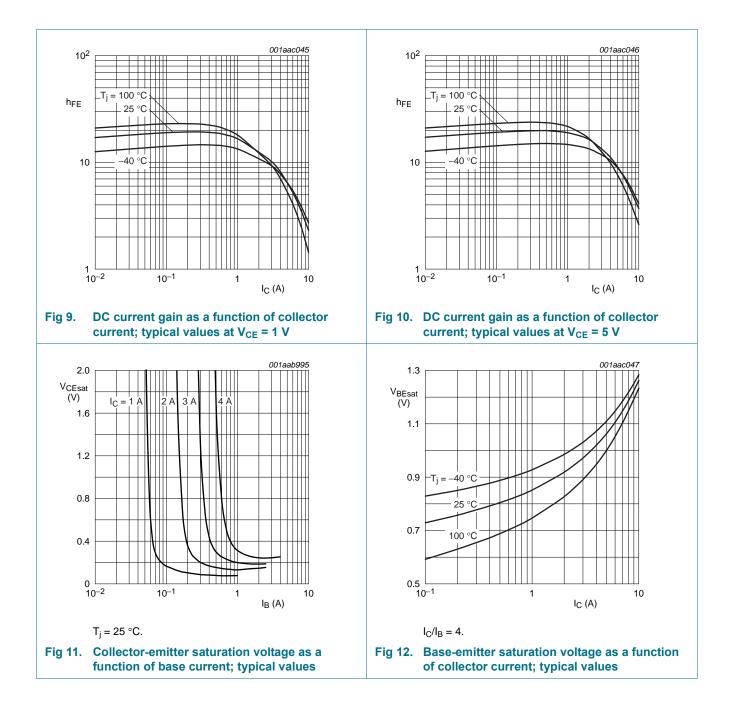
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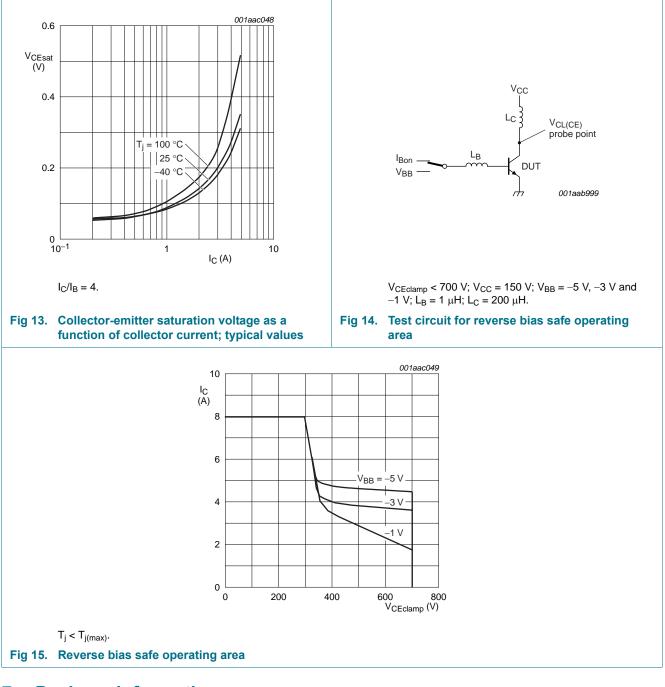
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7. Package information

Epoxy meets requirements of UL94 V-0 at $\frac{1}{8}$ inch.

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8. Package outline

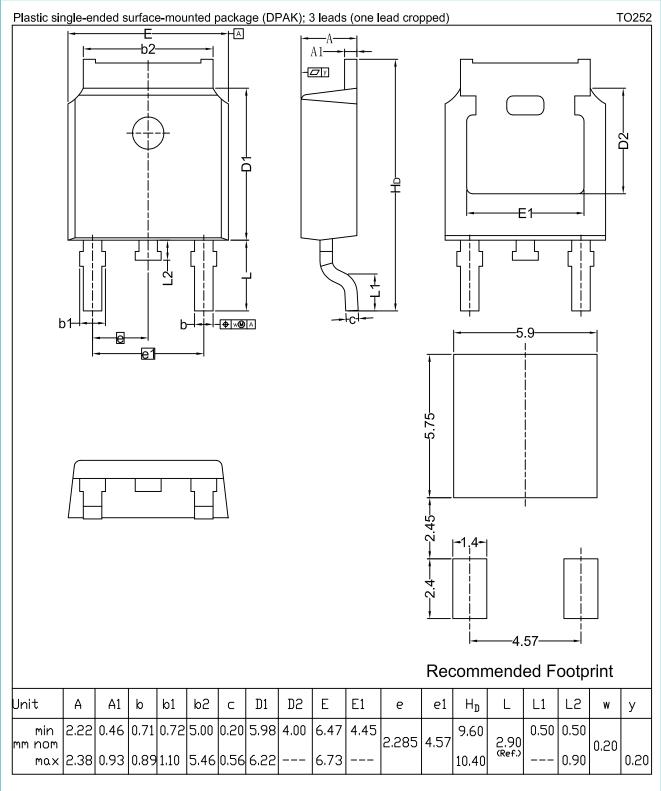


Fig. 15. Package outline DPAK (SOT428)

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Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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